

04/01/2013



U.S. DEPARTMENT OF COMMERCE

103656993

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MRO 3-28-13

1. Name of conveying parties:

1.) Jin Young CHOI	5.) Doo Woong LEE
2.) Jun Ho JI	6.) You Seop LEE
3.) Du Seop YOON	7.) Jun Young LEE
4.) Byeong Cheol YOON	8.) In Sang HWANG

2. Name and Address of receiving party:
 SAMSUNG ELECTRONICS CO., LTD.
 129, Samsung-ro, Yeongtong-gu,
 Suwon-si, Gyeonggi-do 443-742
 Republic of Korea

3. Nature of conveyance:

<input checked="" type="checkbox"/> Assignment	<input type="checkbox"/> Merger
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Other: _____	

 Execution Date(s): March 11, 2013

4. Application number(s) or patent number(s):

This document is being filed together with a new application.

OR

This document is being filed after filing of the application:

(a) Patent Application No(s). 13/800,759, filed March 13, 2013; or

(b) Patent No(s). , issued .

5. Name and address of party to whom correspondence concerning document should be mailed:
 STAAS & HALSEY LLP Our Docket: 2294.1718
 Attention: Sonny S. Choi
 1201 New York Ave., N.W., 7th Floor
 Washington, D.C. 20005

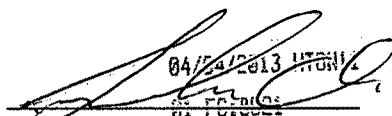
6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)..... (\$ 40.00 per Patent or Application in Assignment)

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8. Deposit Account No.: 19-3935 (Any underpayment is authorized to be charged to this Deposit Account)

Sonny S. Choi, Reg. No. 65,889
Name of Person Signing


 Signature

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 Date

Total number of pages including cover sheet: 2

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U.S. ASSIGNMENT

5&11-100

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

(Insert Name(s) & Address(es) of ASSIGNEE(S))
SAMSUNG ELECTRONICS CO., LTD.
 129, Samsung-ro, Yeongtong-gu,
 Suwon-si, Gyeonggi-do 443-742
 Republic of Korea

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled:
 (Title of Invention)

HUMIDIFIER

relating to International Patent Application PCT/JP _____ and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on :

(Insert date of execution of application, if not concurrent)

(b) filed on :

Serial No. :

Any registered attorney of STAAS & HALSEY U.P., 1201 New York Avenue, N.W., Suite 700, Washington, D.C. 20005 (202/434-1500) is hereby authorized to insert in (b) the specified data, when known.

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The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Typed Name & Signature of Inventor(s))

(Date)

(Typed Name & Signature of Witness(es))

- | | | | |
|----|-----------------------|---------------|-------|
| 1) | <i>Jin Young Choi</i> | Mar. 11, 2013 | _____ |
| | Jin Young CHOI | | |
| 2) | <i>Junho Ji</i> | Mar. 11, 2013 | _____ |
| | Jun Ho JI | | |
| 3) | <i>Du Seop Yoon</i> | Mar. 11, 2013 | _____ |
| | Du Seop YOON | | |
| 4) | <i>[Signature]</i> | Mar. 11, 2013 | _____ |
| | Byeong Cheol YOON | | |
| 5) | <i>[Signature]</i> | Mar. 11, 2013 | _____ |
| | Doo Woong LEE | | |
| 6) | <i>Yoo Seop Lee</i> | Mar. 11, 2013 | _____ |
| | Yoo Seop LEE | | |
| 7) | <i>[Signature]</i> | Mar. 11, 2013 | _____ |
| | Jun Young LEE | | |
| 8) | <i>In Sang Huang</i> | Mar. 11, 2013 | _____ |
| | In Sang HWANG | | |

PATENT